

RoHS

COMPLIANT

HALOGEN FREE

# Ultrafast Rectifier, 20 A FRED Pt®





PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	20 A			
$V_{R}$	600 V			
V <sub>F</sub> at I <sub>F</sub>	1.26 V			
t <sub>rr</sub> (typ.)	61 ns			
T <sub>J</sub> max.	175 °C			
Package	2L TO-220 FullPAK			
Circuit configuration	Single			

#### **FEATURES**

- Low forward voltage drop
- · Ultrafast soft recovery time
- 175 °C operating junction temperature
- · Low leakage current
- Fully isolated package (V<sub>INS</sub> = 2500 V<sub>RMS</sub>)
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912">www.vishav.com/doc?99912</a>

#### **DESCRIPTION**

Ultralow  $V_F$ , soft-switching ultrafast rectifiers optimized for Discontinuous (Critical) Mode (DCM) Power Factor Correction (PFC).

The minimized conduction loss, optimized stored charge and low recovery current minimized the switching losses and reduce over dissipation in the switching element and snubbers.

The device is also intended for use as a freewheeling diode in power supplies and other power switching applications.

#### **APPLICATIONS**

AC/DC SMPS 70 W to 400 W

e.g. laptop and printer AC adaptors, desktop PC, TV and monitor, games units and DVD AC/DC power supplies.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Peak repetitive reverse voltage	V <sub>RRM</sub>		600	V	
Average rectified forward current in DC	I <sub>F(AV)</sub>	T <sub>C</sub> = 102 °C	20	^	
Non-repetitive peak surge current	I <sub>FSM</sub>	T <sub>J</sub> = 25 °C	190	A	
Operating junction and storage temperatures	T <sub>J</sub> , T <sub>Stg</sub>		-55 to +175	°C	

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Breakdown voltage, blocking voltage	V <sub>BR</sub> , V <sub>R</sub>	I <sub>R</sub> = 100 μA	600	-	-	.,
Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 20 A	-	1.4	1.63	V
r of ward voltage	I <sub>F</sub> = 20 A, T <sub>J</sub> = 125 °C	-	1.26	1.49		
Payaraa laakaga aurrant		$V_R = V_R$ rated	-	0.3	15	
Reverse leakage current I <sub>R</sub>		T <sub>J</sub> = 125 °C, V <sub>R</sub> = V <sub>R</sub> rated	-	50	500	μA
Junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 600 V	-	18	-	pF
Series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from package body	-	8	-	nH



<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Reverse recovery time	+	T <sub>J</sub> = 25 °C		-	61	-	ns
neverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 125 °C	I <sub>F</sub> = 20 A dI <sub>F</sub> /dt = 1000 A/μs V <sub>R</sub> = 400 V	-	87	-	
Deelineerine	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C		-	13	-	Α
Peak recovery current		T <sub>J</sub> = 125 °C		-	21	-	_ ^
Reverse recovery charge Q <sub>rr</sub>	0	T <sub>J</sub> = 25 °C		-	480	-	nC
	Q <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	1080	-	IIC

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-55	-	175	°C
Thermal resistance, junction to case	R <sub>thJC</sub>		-	2.5	3	
Thermal resistance, junction to ambient	R <sub>thJA</sub>	Typical socket mount	70 °C/W		°C/W	
Typical thermal resistance, case to heatsink	R <sub>thCS</sub>	Mounting surface, flat, smooth, and greased - 0.5 -				
Mojobt			-	2	-	g
Weight			-	0.07	-	oz.
Mounting torque			6	_	12	kgf · cm
Woulding torque			(5)		(10)	(lbf · in)
Marking device		Case style: 2L TO-220 FullPAK	E4TU2006FP			

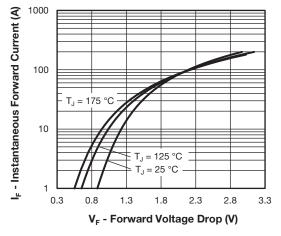


Fig. 1 - Typical Forward Voltage Drop Characteristics

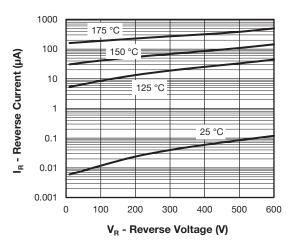


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

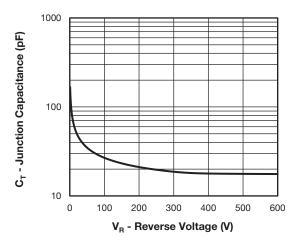


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

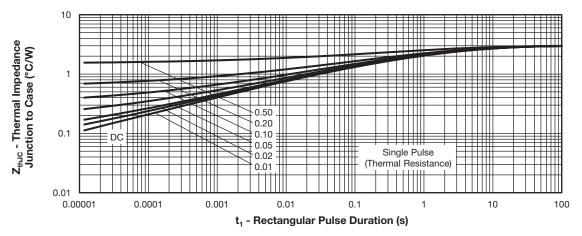


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

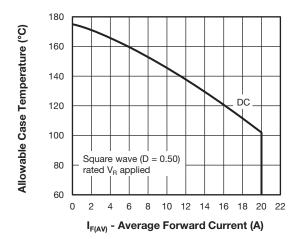


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

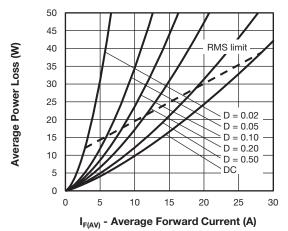
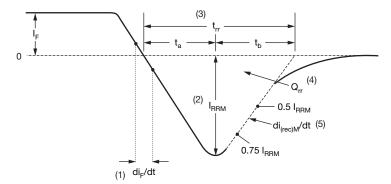


Fig. 6 - Forward Power Loss Characteristics





- (1) di<sub>F</sub>/dt rate of change of current through zero crossing
- (2) I<sub>RRM</sub> peak reverse recovery current
- (3)  $\rm t_{rr}$  reverse recovery time measured from zero crossing point of negative going  $\rm I_F$  to point where a line passing through 0.75  $\rm I_{RRM}$  and 0.50  $\rm I_{RRM}$  extrapolated to zero current.
- (4)  $\rm Q_{rr}$  area under curve defined by  $\rm t_{rr}$  and  $\rm I_{RRM}$

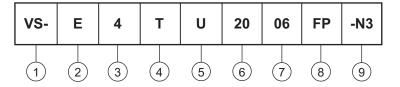
$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) di<sub>(rec)M</sub>/dt - peak rate of change of current during t<sub>b</sub> portion of t<sub>rr</sub>

Fig. 7 - Reverse Recovery Waveform and Definitions

#### **ORDERING INFORMATION TABLE**

#### **Device code**



- 1 Vishay Semiconductors product
- 2 Circuit configuration:

E = single diode

3 - 4 = Gen 4 FRED Pt

4 - T = TO-220

5 - U = ultrafast recovery time

6 - Current code: 20 = 20 A

7 - Voltage code: 06 = 600 V

8 - FP = FullPAK

9 - Environmental digit:

-N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

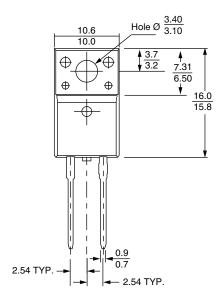
ORDERING INFORMATION (Example)					
PREFERRED P/N QUANTITY PER TUBE MINIMUM ORDER QUANTITY PACKAGING DESCRIPTION					
VS-E4TU2006FP-N3	50	1000	Antistatic plastic tube		

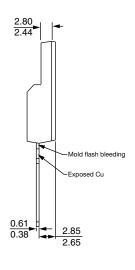
LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?96157			
Part marking information	www.vishay.com/doc?95392			

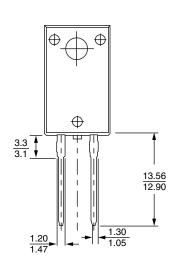


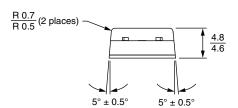
## 2L TO-220 FullPAK

#### **DIMENSIONS** in millimeters









Bottom view



### **Legal Disclaimer Notice**

Vishay

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